

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:** Chopra et al.

**Serial No.:** 10/620,002

**Filed:** July 14, 2003

**For:** SLURRY FOR USE WITH FIXED-  
ABRASIVE POLISHING PADS IN  
POLISHING SEMICONDUCTOR DEVICE  
CONDUCTIVE STRUCTURES THAT  
INCLUDE COPPER AND A COPPER  
BARRIER (as amended)

**Confirmation No.:** 7481

**Examiner:** L. Vinh

**Group Art Unit:** 1792

**Attorney Docket No.:** 2269-4373.2US

VIA ELECTRONIC FILING  
July 11, 2008

**AMENDMENT ACCOMPANYING REQUEST FOR CONTINUED EXAMINATION**

Mail Stop RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Examiner:

This Amendment and the Request for Continued Examination (RCE) that it accompanies follow the Advisory Action of June 19, 2008, and the final Office Action of April 11, 2008, the shortened statutory period for response to which expires on July 11, 2008.

A listing of claims, in which revisions to the claims are presented, begins on page 2 of this paper; and

Remarks start at page 6 of this paper.